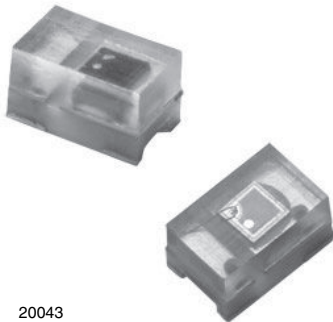


## Silicon Phototransistor in 0805 Package



20043

### DESCRIPTION

TEMT7000X01 is a high speed silicon NPN epitaxial planar phototransistor in a miniature 0805 package for surface mounting on printed boards. The device is sensitive to visible and near infrared radiation.

### FEATURES

- Package type: surface-mount
- Package form: 0805
- Dimensions (L x W x H in mm): 2 x 1.25 x 0.85
- AEC-Q101 qualified
- High photo sensitivity
- High radiant sensitivity
- Suitable for visible and near infrared radiation
- Fast response times
- Angle of half sensitivity:  $\varphi = \pm 60^\circ$
- Package matched with IR emitter series VSMB1940X01
- Floor life: 168 h, MSL 3, according to J-STD-020
- Lead (Pb)-free reflow soldering
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)

AUTOMOTIVE GRADE


**RoHS**  
 COMPLIANT  
 HALOGEN  
**FREE**  
**GREEN**  
 (5-2008)

### APPLICATIONS

- Detector in automotive applications
- Light sensors
- Radiation sensors

### PRODUCT SUMMARY

COMPONENT	$I_{ca}$ ( $\mu A$ ) at $E_e = 1 \text{ mW/cm}^2$ , $\lambda = 950 \text{ nm}$ , $V_{CE} = 5 \text{ V}$	$\varphi$ ( $^\circ$ )	$\lambda_{0.1}$ (nm)
TEMT7000X01	225 to 675	$\pm 60$	470 to 1090

#### Note

- Test condition see table "Basic Characteristics"

### ORDERING INFORMATION

ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM
TEMT7000X01	Tape and reel	MOQ: 3000 pcs, 3000 pcs/reel	0805

#### Note

- MOQ: minimum order quantity

### ABSOLUTE MAXIMUM RATINGS ( $T_{amb} = 25^\circ C$ , unless otherwise specified)

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Collector emitter voltage		$V_{CEO}$	20	V
Emitter collector voltage		$V_{ECO}$	7	V
Collector current		$I_C$	20	mA
Power power dissipation	$T_{amb} \leq 55^\circ C$	$P_V$	100	mW
Junction temperature		$T_j$	100	$^\circ C$
Operating temperature range		$T_{amb}$	-40 to +100	$^\circ C$
Storage temperature range		$T_{stg}$	-40 to +100	$^\circ C$
Soldering temperature	According to reflow profile Fig. 8	$T_{sd}$	260	$^\circ C$
Thermal resistance junction-to-ambient	According to J-STD-051	$R_{thJA}$	270	K/W

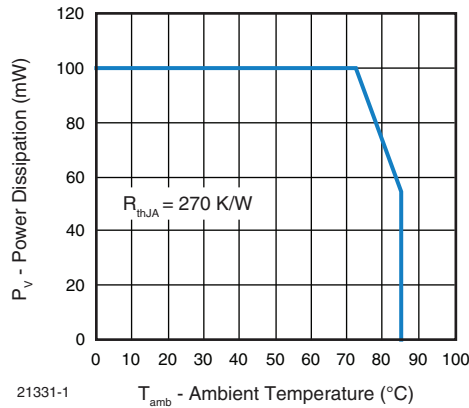


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

BASIC CHARACTERISTICS ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Collector emitter breakdown voltage	$I_C = 0.1\text{ mA}$	$V_{CEO}$	20	-	-	V
Collector dark current	$V_{CE} = 5\text{ V}, E = 0$	$I_{CEO}$	-	1	100	nA
Collector emitter capacitance	$V_{CE} = 0\text{ V}, f = 1\text{ MHz}, E = 0$	$C_{CEO}$	-	25	-	pF
Collector light current	$E_e = 1\text{ mW/cm}^2, \lambda = 950\text{ nm}, V_{CE} = 5\text{ V}$	$I_{CA}$	225	450	675	$\mu\text{A}$
Angle of half sensitivity		$\varphi$	-	$\pm 60$	-	$^{\circ}$
Wavelength of peak sensitivity		$\lambda_p$	-	850	-	nm
Range of spectral bandwidth		$\lambda_{0.1}$	-	470 to 1090	-	nm
Collector emitter saturation voltage	$I_C = 0.05\text{ mA}$	$V_{CEsat}$	-	-	0.4	V
Temperature coefficient of $I_{ca}$	$E_e = 1\text{ mW/cm}^2, \lambda = 950\text{ nm}, V_{CE} = 5\text{ V}$	$Tk_{Ica}$	-	1.1	-	%/K

**BASIC CHARACTERISTICS** ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)

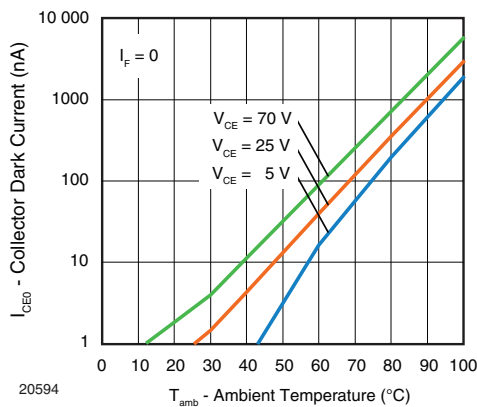


Fig. 2 - Collector Dark Current vs. Ambient Temperature

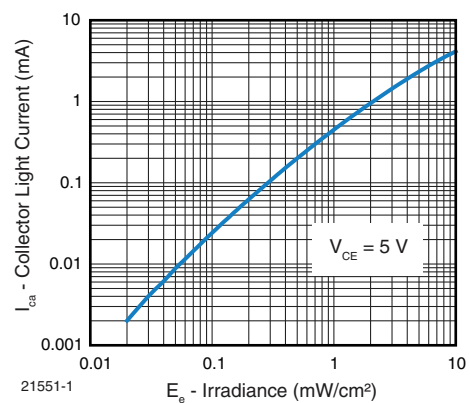


Fig. 3 - Collector Light Current vs. Irradiance

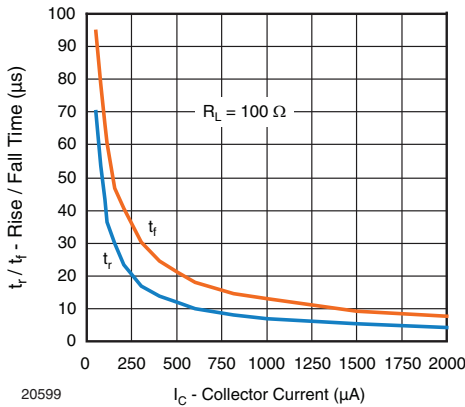


Fig. 4 - Rise/Fall Time vs. Collector Current

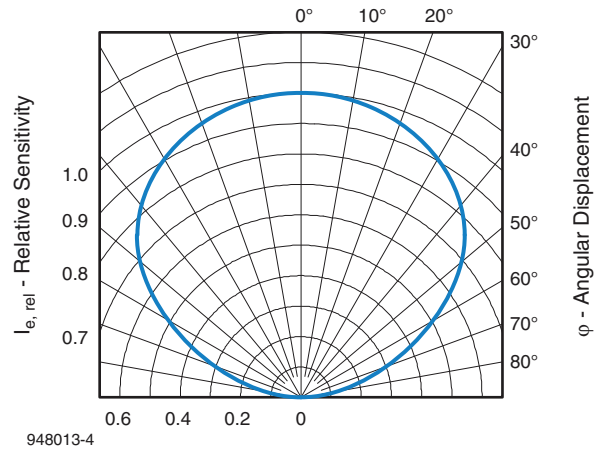


Fig. 6 - Relative Sensitivity vs. Angular Displacement

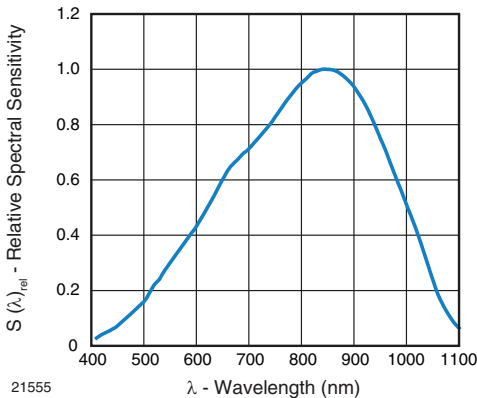


Fig. 5 - Relative Spectral Sensitivity vs. Wavelength

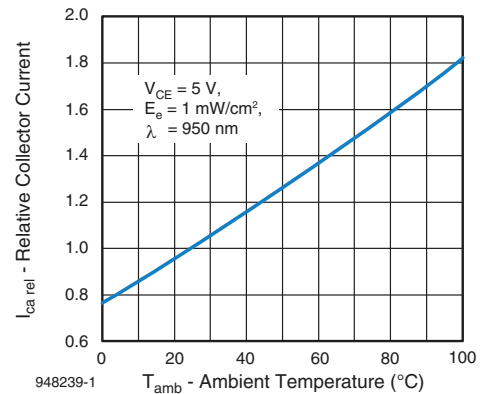


Fig. 7 - Relative Collector Current vs. Ambient Temperature

**REFLOW SOLDER PROFILE**

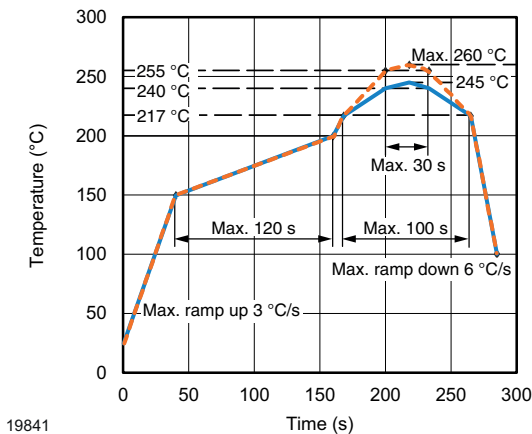


Fig. 8 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020

**DRYPACK**

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

**FLOOR LIFE**

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label:

Floor life: 168 h

Conditions:  $T_{amb} < 30\text{ °C}$ ,  $RH < 60\%$

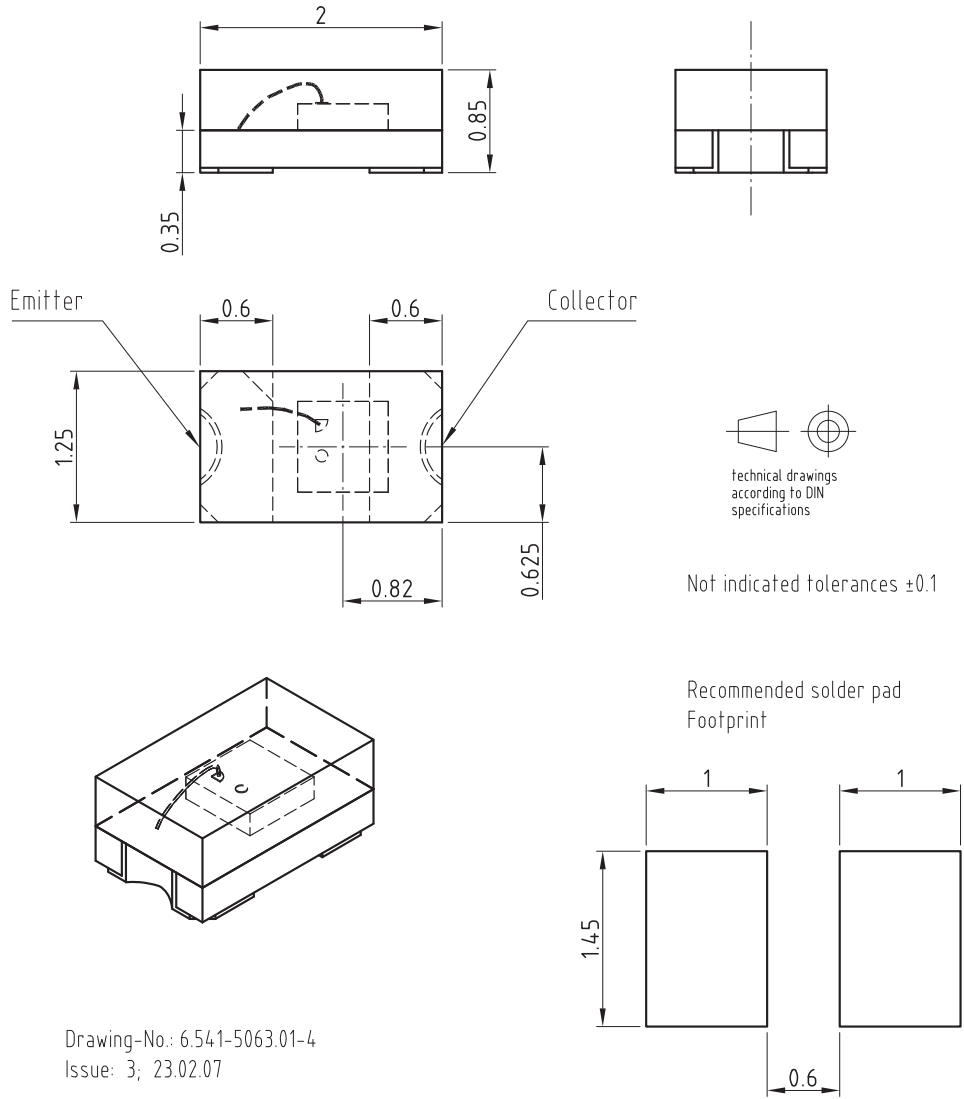
Moisture sensitivity level 3, acc. to J-STD-033D.

**DRYING**

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at  $40\text{ °C}$  (+  $5\text{ °C}$ ),  $RH < 5\%$ .



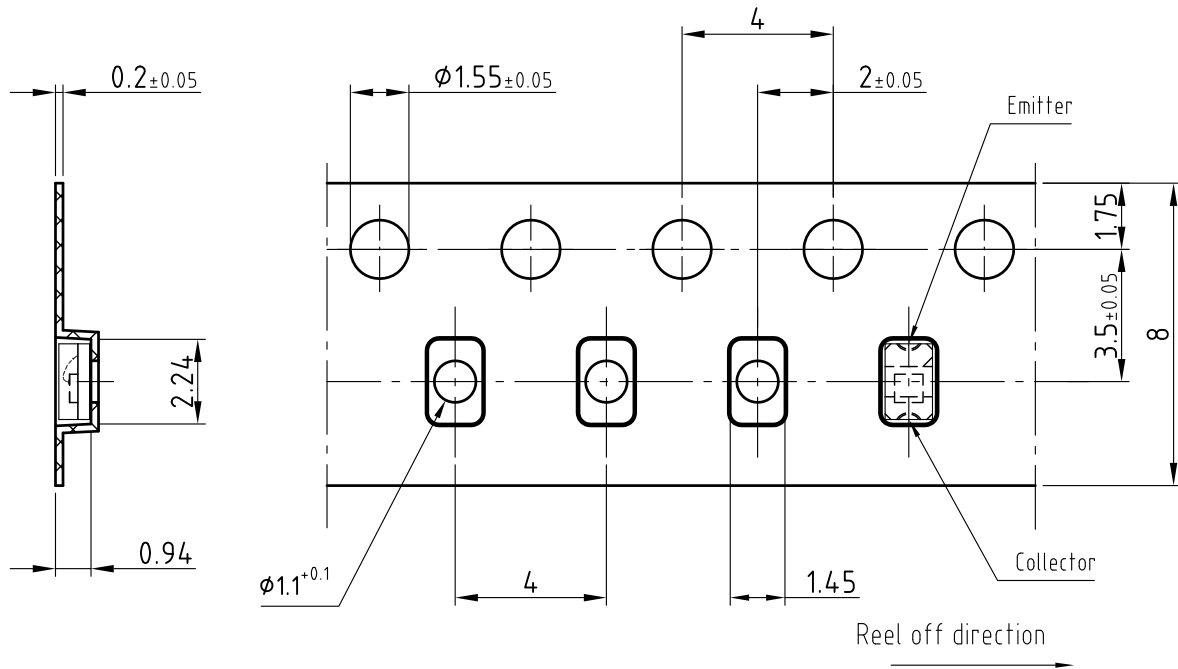
**PACKAGE DIMENSIONS** in millimeters



Drawing-No.: 6.541-5063.01-4  
Issue: 3; 23.02.07  
19757



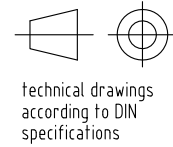
BLISTER TAPE DIMENSIONS in millimeters



Drawing-No.: 9.700-5310.01-4  
 Issue: 2; 14.08.07  
 20690

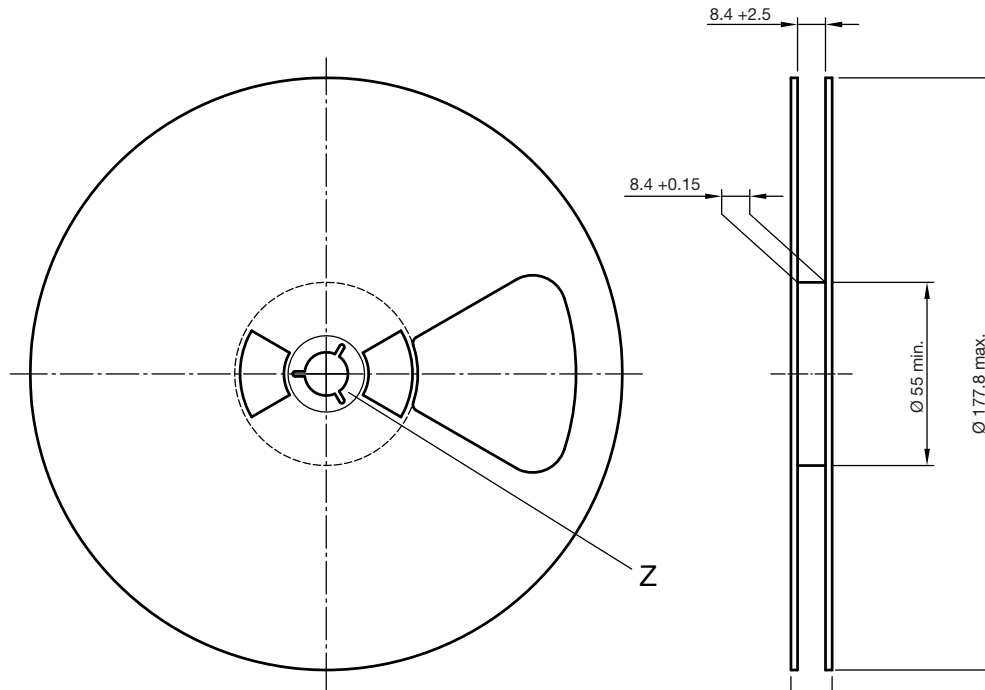
Not indicated tolerances  $\pm 0.1$

Quantity per reel: 3000 pcs

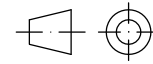
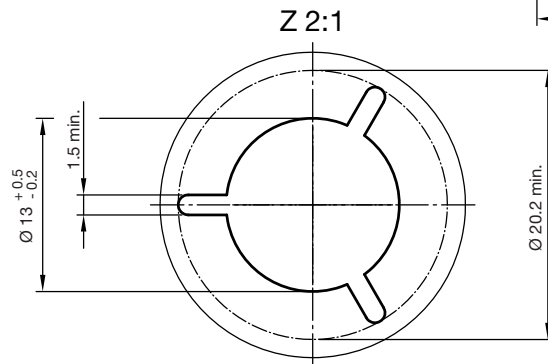




REEL DIMENSIONS in millimeters



Form of the leave open of the wheel is supplier specific.



technical drawings according to DIN specifications

Drawing-No.: 9.800-5096.01-4  
Issue: 2; 26.04.10  
20875



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